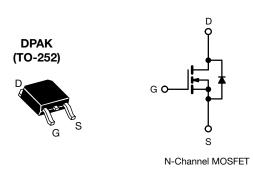
**Vishay Siliconix** 

VISHAY, www.vishay.com

## **E Series Power MOSFET**



PRODUCT SUMMA	RY	
$V_{DS}$ (V) at $T_J$ max.	650	)
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.320
Q <sub>g</sub> max. (nC)	52	
Q <sub>gs</sub> (nC)	6	
Q <sub>gd</sub> (nC)	13	
Configuration	Sing	le

#### FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (C<sub>iss</sub>)
- Reduced switching and conduction losses
- Ultra low gate charge (Qg)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
- Welding
- Induction heating
- Motor drives
- Battery chargers
- Renewable energy
- Solar (PV inverters)

ORDERING INFORMATION	
Package	DPAK (TO-252)
Lead (Pb)-free and halogen-free	SiHD9N60E-GE3

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub>	= 25 °C, unle	ess otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V <sub>DS</sub>	600	v
Gate-source voltage			V <sub>GS</sub>	± 30	v
Continuous drain surrent (T 150 °C)	V at 10 V	T <sub>C</sub> = 25 °C T <sub>C</sub> = 100 °C		9	
Continuous drain current ( $T_J = 150 \ ^\circ C$ )	V <sub>GS</sub> at 10 V	$T_C = 100 \ ^\circ C$	ID	6	А
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	22	
Linear derating factor				0.63	W/°C
Single pulse avalanche energy <sup>b</sup>			E <sub>AS</sub>	111	mJ
Maximum power dissipation			P <sub>D</sub>	78	W
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C
Drain-source voltage slope	T <sub>J</sub> = 125 °C		-0.77-11	70	
Reverse diode dV/dt <sup>d</sup>	•		dV/dt	40	V/ns
Soldering recommendations (peak temperature) <sup>c</sup>	For <sup>2</sup>	10 s		300	°C

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b.  $V_{DD}$  = 140 V, starting T<sub>J</sub> = 25 °C, L = 28.2 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 2.8 A.

c. 1.6 mm from case.

d.  $I_{SD} \leq I_D, \, dI/dt$  = 100 A/µs, starting  $T_J$  = 25 °C.

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COMPLIANT

HALOGEN

FREE

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THERMAL RESISTANCE RATI	NGS							
PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-		62			°C/W	
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-		1.6			0/10	
SPECIFICATIONS (T <sub>J</sub> = 25 $^{\circ}$ C, u	Inless otherwi	se noted)						
PARAMETER	SYMBOL	TES	<b>F CONDIT</b>	IONS	MIN.	TYP.	MAX.	UNIT
Static								
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> =	250 µA	600	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C,	$I_D = 1 \text{ mA}$	-	0.71	-	V/°C
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	$V_{GS}, I_D =$	250 µA	2.5	-	4.5	V
		$V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA	
Gate-source leakage	I <sub>GSS</sub>	$V_{GS} = \pm 30 \text{ V}$		-	-	± 1	μA	
Zara gata valtaga drain aurrant		V <sub>DS</sub> =	V <sub>DS</sub> = 600 V, V <sub>GS</sub> = 0 V		-	-	1	<u>,</u>
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 480 V	′, V <sub>GS</sub> = 0 V	/, T <sub>J</sub> = 125 °C	-	-	10	μA
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I	<sub>D</sub> = 4.5 A	-	0.320	0.368	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> :	= 30 V, I <sub>D</sub> =	= 4.5 A	-	2.4	-	S
Dynamic								
Input capacitance	C <sub>iss</sub>		V <sub>GS</sub> = 0 V	<u>,</u>	-	778	-	
Output capacitance	C <sub>oss</sub>	$V_{DS} = 100 V,$ f = 1 MHz		-	48	-	pF	
Reverse transfer capacitance	C <sub>rss</sub>			-	4	-		
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>	V <sub>DS</sub> = 0 V to 480 V, V <sub>GS</sub> = 0 V		-	29	-		
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>	$v_{\rm DS} = 0.0$	10 460 V,	v <sub>GS</sub> = 0 v	-	138	-	
Total gate charge	Qg				-	26	52	
Gate-source charge	Q <sub>gs</sub>	$V_{GS} = 10 V$	I <sub>D</sub> = 4.5	A, V <sub>DS</sub> = 480 V	-	6	-	nC
Gate-drain charge	Q <sub>gd</sub>	-			-	13	-	
Turn-on delay time	t <sub>d(on)</sub>				-	14	28	
Rise time	t <sub>r</sub>	V <sub>DD</sub> =	480 V, I <sub>D</sub>	= 4.5 A,	-	13	26	
Turn-off delay time	t <sub>d(off)</sub>	$V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$		-	31	62	ns	
Fall time	t <sub>f</sub>				-	12	24	
Gate input resistance	R <sub>g</sub>	f = 1 MHz, open drain		0.4	1.2	2.4	Ω	
Drain-Source Body Diode Characteristic	cs							
Continuous source-drain diode current	I <sub>S</sub>	MOSFET symbol showing the		-	-	9		
Pulsed diode forward current	I <sub>SM</sub>	integral revers p - n junction			-	-	22	A
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C	C, I <sub>S</sub> = 4.5 /	A, V <sub>GS</sub> = 0 V	-	-	1.2	V
Reverse recovery time	t <sub>rr</sub>				-	207	414	ns
Reverse recovery charge	Q <sub>rr</sub>	$T_J = 25$	5 °C, Ι <sub>F</sub> = Ι <sub>S</sub> 100 Α/μs, ΄	s = 4.5 A,	-	2.2	4.4	μC
Reverse recovery current	I <sub>RRM</sub>	ai/at =	ιου A/μs,	v <sub>R</sub> = ∠⊃ v		20	-	A

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .

b. Coss(tr) is a fixed capacitance that gives the same charging time as Coss while VDS is rising from 0 % to 80 % VDSS.

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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

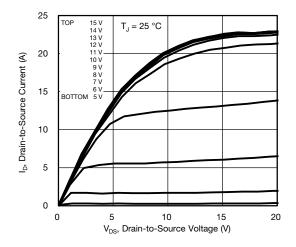
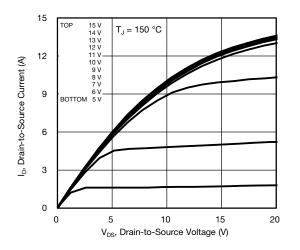
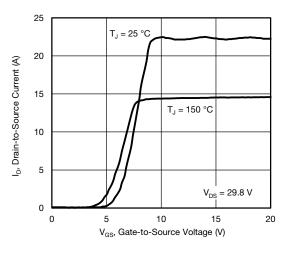


Fig. 1 - Typical Output Characteristics









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3.0 = 4.5 A R<sub>DS(on)</sub>, Drain-to-Source On-Resistance 2.5 2.0 (Normalized) 1.0 = 10 V V<sub>GS</sub> 0.5 0 -60 -40 -20 0 20 40 60 80 100 120 140 160 T<sub>J</sub>, Junction Temperature (°C)

Fig. 4 - Normalized On-Resistance vs. Temperature

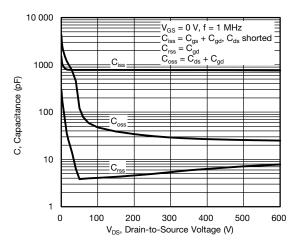


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

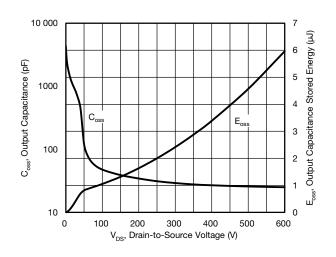


Fig. 6 -  $C_{\rm oss}$  and  $E_{\rm oss}$  vs.  $V_{\rm DS}$ 

3 For technical questions, contact: <u>hvm@vishay.com</u>

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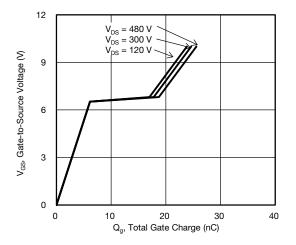


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

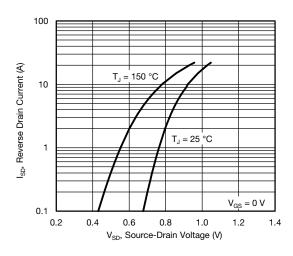


Fig. 8 - Typical Source-Drain Diode Forward Voltage

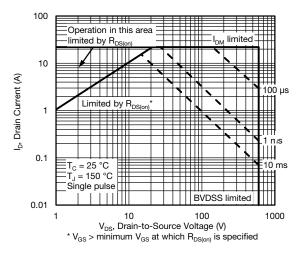


Fig. 9 - Maximum Safe Operating Area

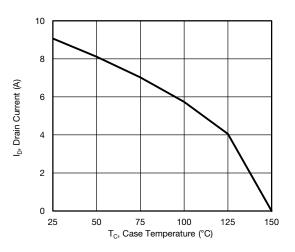


Fig. 10 - Maximum Drain Current vs. Case Temperature

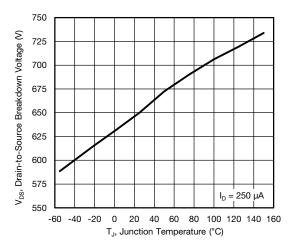


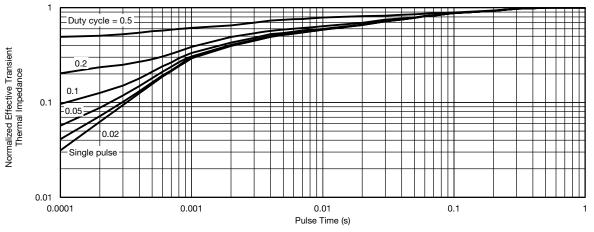
Fig. 11 - Temperature vs. Drain-to-Source Voltage

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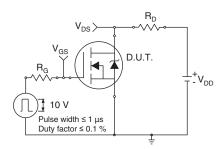


Fig. 13 - Switching Time Test Circuit

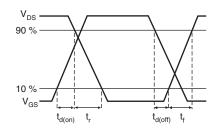


Fig. 14 - Switching Time Waveforms

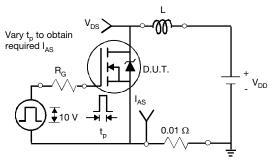


Fig. 15 - Unclamped Inductive Test Circuit

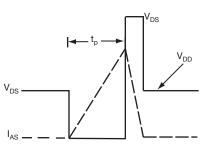


Fig. 16 - Unclamped Inductive Waveforms

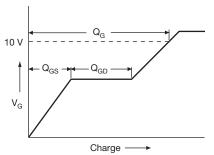


Fig. 17 - Basic Gate Charge Waveform

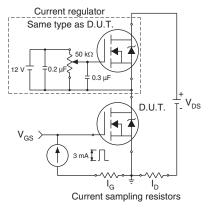


Fig. 18 - Gate Charge Test Circuit

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#### Peak Diode Recovery dV/dt Test Circuit

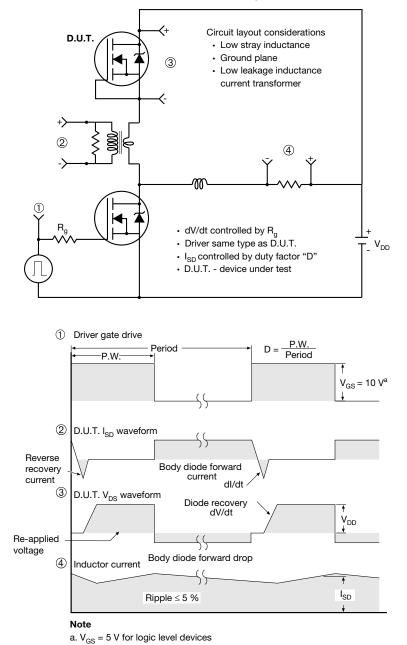


Fig. 19 - For N-Channel

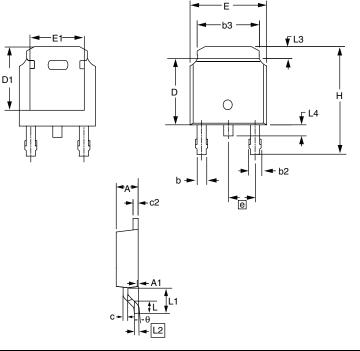
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# **Package Information**

**Vishay Siliconix** 

### **TO-252AA (HIGH VOLTAGE)**



	MILLI	METERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
E	6.40	6.73	0.252	0.265	
L	1.40	1.77	0.055	0.070	
L1	2.74	3 REF	0.108 REF		
L2	0.508	3 BSC	0.020 BSC		
L3	0.89	1.27	0.035	0.050	
L4	0.64	1.01	0.025	0.040	
D	6.00	6.22	0.236	0.245	
Н	9.40	10.40	0.370	0.409	
b	0.64	0.88	0.025	0.035	
b2	0.77	1.14	0.030	0.045	
b3	5.21	5.46	0.205	0.215	
е	2.286	5 BSC	0.090 BSC		
А	2.20	2.38	0.087	0.094	
A1	0.00	0.13	0.000	0.005	
С	0.45	0.60	0.018	0.024	
c2	0.45	0.58	0.018	0.023	
D1	5.30	-	0.209	-	
E1	4.40	-	0.173	-	
θ	0'	10'	0'	10'	

Notes

1. Package body sizes exclude mold flash, protrusion or gate burrs. Mold flash, protrusion or gate burrs shall not exceed 0.10 mm per side.

2. Package body sizes determined at the outermost extremes of the plastic body exclusive of mold flash, gate burrs and interlead flash, but including any mismatch between the top and bottom of the plastic body.

3. The package top may be smaller than the package bottom.

4. Dimension "b" does not include dambar protrusion. Allowable dambar protrusion shall be 0.10 mm total in excess of "b" dimension at maximum material condition. The dambar cannot be located on the lower radius of the foot.



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### **RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)**



Recommended Minimum Pads Dimensions in Inches/(mm)

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